



Product data sheet

1. General description

Passivated, sensitive gate thyristors in a plastic envelope, intended for use in general purpose switching and phase control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

2. Features and benefits

- Sensitive gate
- · Planar passivated for voltage ruggedness and reliability
- Direct triggering from low power drivers and logic ICs
- Surface mountable package

3. Applications

- · General purpose switching and phase control
- · Ignition circuits, CDI for 2- and 3-wheelers
- Motor control e.g. small kitchen appliances

4. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|---------------------|--|--|-----|-----|-----|-----|------|
| V_{DRM} | repetitive peak off-state voltage | | | - | - | 500 | V |
| $I_{T(AV)}$ | average on-state current | half sine wave; T _{mb} ≤ 111 °C; <u>Fig. 1</u> | | - | - | 5 | A |
| I _{T(RMS)} | RMS on-state current | half sine wave; T _{mb} ≤ 111 °C; <u>Fig. 2; Fig. 3</u> | | - | - | 8 | А |
| I _{TSM} | non-repetitive peak on- state current | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5 | | - | - | 75 | A |
| | | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms | | - | - | 82 | А |
| T _j | junction temperature | | [1] | - | - | 125 | °C |
| Static ch | aracteristics | · | | | | | |
| I _{GT} | gate trigger current | V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u> | | - | 50 | 200 | μA |
| Dynamic | characteristics | · | | | | | |
| dV _D /dt | rate of rise of off-state voltage | V_{DM} = 335 V; T _j = 125 °C; R _{GK} = 100 Ω; (V_{DM} = 67% of V_{DRM}); exponential waveform; Fig. 12 | | 50 | 100 | - | V/µs |

[1] Operation above 110°C may require the use of a gate to cathode resistor of $1k\Omega$ or less.

5. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-----------------------------------|--------------------|----------------|
| 1 | К | cathode | mb | |
| 2 | А | anode | 1 2 4 | А₩К |
| 3 | G | gate | | G sym037 |
| mb | A | mounting base; connected to anode | | |

6. Ordering information

| Table 3. Ordering information | | | | | | | | |
|-------------------------------|-----------------|-----------------------|-------------------|---------------------------|-----------------|--------------------|--|--|
| Type number | Package name | Orderable part number | Packing method | Small packing quantity | Package version | Package issue date | | |
| BT258-500R | TO220 | BT258-500R,127 | Tube | 50 | SOT78 | 13-Jun-2008 | | |

7. Marking

Table 4. Marking codes Type number Marking codes Assembly factory: d Assembly factory: A BT258-500R BT258 BT258 BT258-500R BT258 BT258 PJdxxxx xx PJAxxxx xx PJAxxxx xx

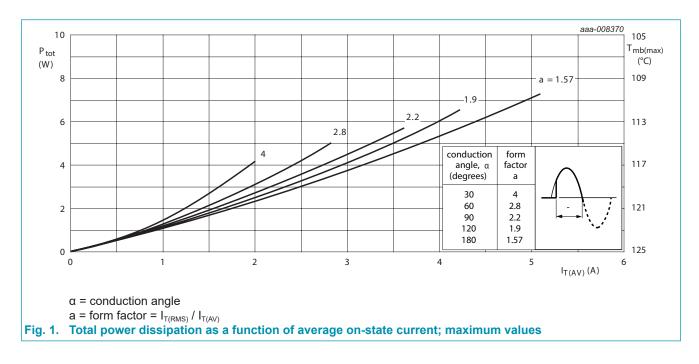
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

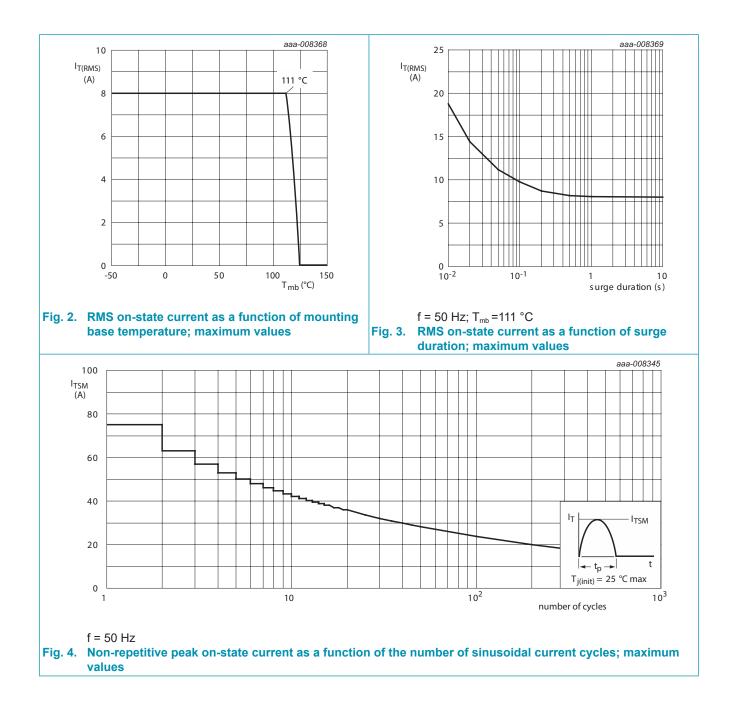
| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---------------------|--|---|-----|-----|-----|------------------|
| V_{DRM} | repetitive peak off-state voltage | | | - | 500 | V |
| V_{RRM} | repetitive peak reverse voltage | | | - | 500 | V |
| I _{T(AV)} | average on-state current | half sine wave; T _{mb} ≤ 111 °C; <u>Fig. 1</u> | | - | 5 | А |
| I _{T(RMS)} | RMS on-state current | half sine wave; T _{mb} ≤ 111 °C; <u>Fig. 2; Fig. 3</u> | | - | 8 | А |
| I _{TSM} | non-repetitive peak on- state current | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5 | | - | 75 | A |
| | | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms | | - | 82 | А |
| l ² t | l ² t for fusing | t _p = 10 ms; SIN | | - | 28 | A ² s |
| dl _T /dt | rate of rise of on-state current | I_{T} = 10 A; I_{G} = 50 mA; d I_{G} /dt = 50 mA/µs | | - | 50 | A/µs |
| I _{GM} | peak gate current | | | - | 2 | А |
| V _{RGM} | peak reverse gate voltage | | | - | 5 | V |
| P_{GM} | peak gate power | | | - | 5 | W |
| P _{G(AV)} | average gate power | over any 20 ms period | | - | 0.5 | W |
| T _{stg} | storage temperature | | | -40 | 150 | °C |
| T _i | junction temperature | | [1] | - | 125 | °C |

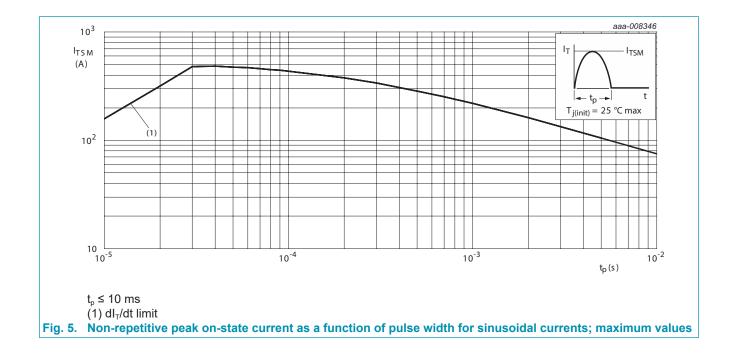
[1] Operation above 110°C may require the use of a gate to cathode resistor of $1k\Omega$ or less.



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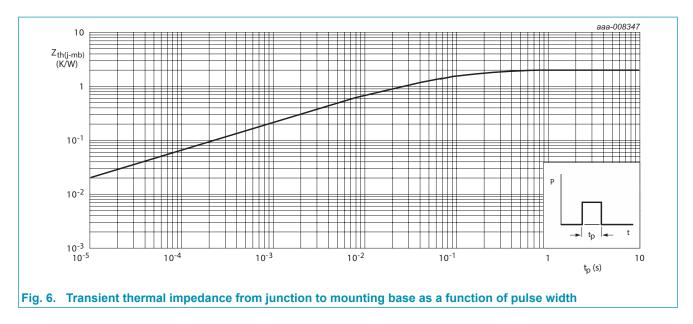
BT258-500R Logic level thyristor





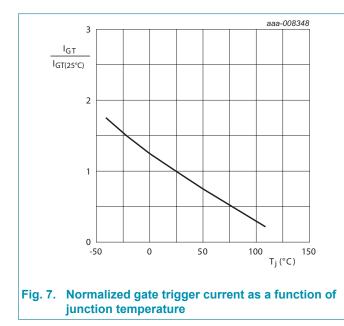
9. Thermal characteristics

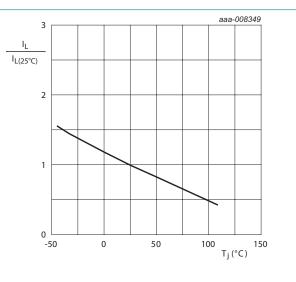
| Symbol | Parameter | Conditions | Min | Тур | Мах | Unit |
|----------------|--|---------------|-----|-----|-----|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base | <u>Fig. 6</u> | - | - | 2 | K/W |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient free air | in free air | - | 60 | - | K/W |



10. Characteristics

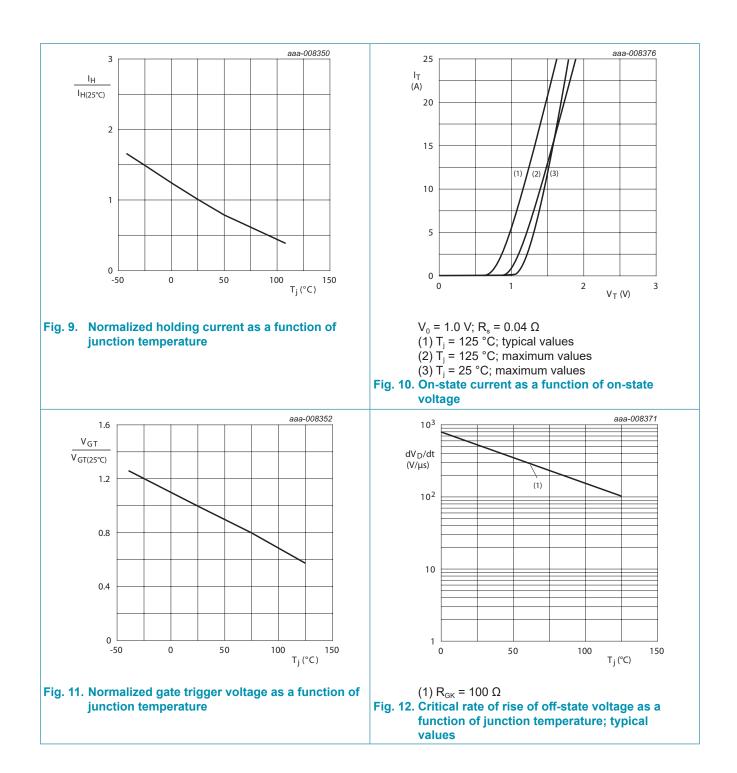
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|---|---------|-----|---------|------|
| | aracteristics | | | | interve | |
| I _{GT} | gate trigger current | V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u> | - | 50 | 200 | μA |
| I _L | latching current | V _D = 12 V; I _G = 0.1 A; T _j = 25 °C; <u>Fig. 8</u> | - | 0.4 | 10 | mA |
| I _H | holding current | V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u> | - | 0.4 | 6 | mA |
| V _T | on-state voltage | I _T = 16 A; T _j = 25 °C; <u>Fig. 10</u> | - | 1.3 | 1.6 | V |
| V_{GT} | gate trigger voltage | V _D = 12 V; I _T = 0.1 A;T _j = 25 °C; <u>Fig. 11</u> | - | 0.4 | 1 | V |
| | | V _D = 500V; I _T = 0.1 A;T _j = 110 °C | 0.1 | 0.2 | - | V |
| I _D | off-state current | V _D = 500 V; T _j = 125 °C | - | 0.1 | 0.5 | mA |
| I _R | reverse current | V _R = 500 V; T _j = 125 °C | - | 0.1 | 0.5 | mA |
| Dynamic | characteristics | | | | | |
| dV _D /dt | rate of rise of off-state voltage | V_{DM} = 335 V; T _j = 125 °C; R _{GK} = 100 Ω; (V _{DM} = 67% of V _{DRM}); exponential waveform; Fig. 12 | 50 | 100 | - | V/µs |
| t _{gt} | gate-controlled turn-on time | $I_{TM} = 10 \text{ A}; V_D = 500 \text{ V}; I_G = 5 \text{ mA};$ $dI_G/dt = 0.2 \text{ A}/\mu\text{s}; T_j = 25 \text{ °C}$ | - | 2 | - | μs |
| t _q | commutated turn-off time | | - | 100 | - | μs |





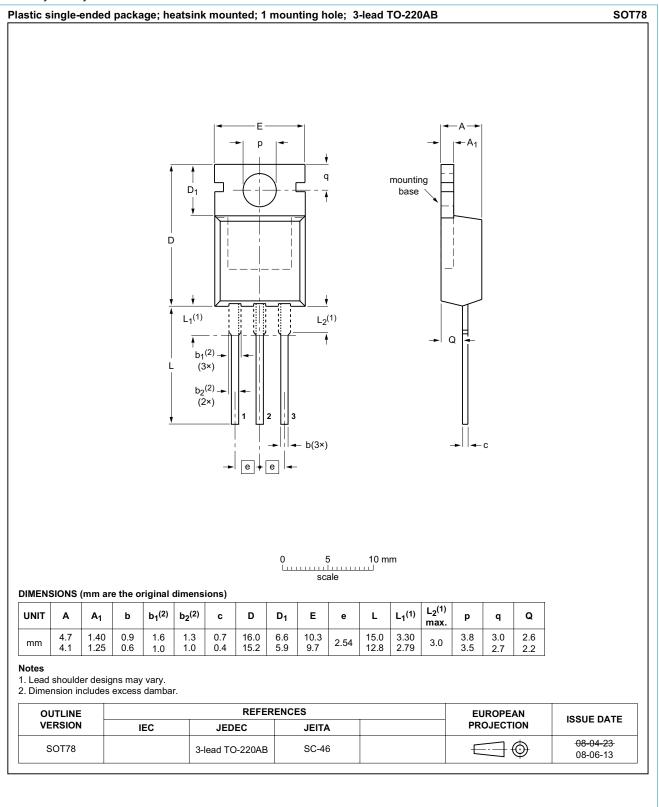


BT258-500R Logic level thyristor



11. Package outline

Assembly factory: d & A



12. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.ween-semi.com</u>.

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